



The 37th
International Symposium on
Power Semiconductor Devices and ICs

Date June 1-5, 2025

Venue Kumamoto-Jo Hall, Kumamoto, Japan

ISPSD
2025

Sponsorship and Exhibition Prospectus

The 37th International Symposium on Power Semiconductor Devices and ICs (ISPSD) will be held from June 1 to 5, 2025, at the Kumamoto-Jo Hall, Kumamoto, Japan.

IEEE ISPSD is the premier forum for technical discussions in all areas of power semiconductor devices and power integrated circuits, with an annual attendance of 500 or more engineers, scientists, professors, and students from around the world.

ISPSD2025 will be held in Kumamoto City, located in the heart of Kyushu Island, where it has a rich historical significance and has recently gained tremendous attention in the semiconductor industry, including power semiconductors.

A three-and-a-half day exhibition will be opened in conjunction with the technical symposium, providing a unique opportunity for exhibitors to showcase their products and services closely related to the power semiconductor industry. Each sponsorship and exhibition package includes extensive sponsor/exhibitor logo exposure in the symposium materials, official website, announcement slides in the symposium rooms, and more.

We believe this is an essential and "must have" opportunity to promote your presence and profile to researchers, engineers and potential customers.

We would like to ask for your support and cooperation to make this ISPSD2025 a great success with your understanding of the importance of this event.



Ichiro Omura

General Chair

Organizing committee of ISPSD2025



Yuichi Onozawa

Technical Program Chair

Organizing committee of ISPSD2025

Inquiry:

Secretariat of ISPSD2025

c/o Convention Linkage, Inc.

Email: ISPSD2025@c-linkage.co.jp



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Symposium Outline

Symposium Name: The 37th International Symposium on Power Semiconductor Devices and ICs (ISPSD2025)

Dates: June 1 (Sun.) - June 5 (Thu.), 2025

Venue: [Kumamoto-Jo Hall](#)
(3-40, Sakuramachi, Chuo-ku, Kumamoto-city, Kumamoto, 860-0805, Japan)

Expected Number of participants: 700 (450 from domestic + 250 from overseas)

Expected Number of Presentations: 160 (60 oral presentations + 100 poster presentations)

General Chair: Ichiro Omura (Kyushu Institute of Technology, Japan)

Technical Program Chair: Yuichi Onozawa (Fuji Electric, Japan)

Sponsor: The Institute of Electrical Engineers of Japan

Technical Co-Sponsors: Institute of Electrical and Electronics Engineers
The IEEE Electron Devices Society
The IEEE Power Electronics Society
The IEEE Industry Applications Society

Supported by JSPS KAKENHI Grant #JP24HP0701

Main Categories of Interest: High Voltage Power Devices
LV Power Devices and Power IC Technology
Power IC Design
GaN and Compound Materials
SiC and Other Materials
Module and Packaging Technologies

Secretariat: c/o Convention Linkage, Inc.
2-17 Sakuramachi, Chuo-ku, Kumamoto-city 860-0805, Japan
Phone: +81-96-288-0882, Fax: +81-96-288-0883
Email: ISPSD2025@c-linkage.co.jp



IEEE





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ON A FIRST-COME, FIRST-SERVED BASIS

Sponsorship Packages

Benefits	Categories			
	Diamond	Gold	Silver	Exhibitor
Fee*1	JPY 1,500,000	JPY 800,000	JPY 500,000	JPY 400,000 per booth
Number of Availability	4	8	10	32
Logo on - Official Website - Screens in Symposium Hall - Symposium Program Book - Signboards / Banners	Extra-Large	Large	Medium	Small
Advertisement in Symposium Brochure	Full page (at front)	1/2 page (at back)	1/3 page (at back)	N/A
Promotional Video during Breaks or before/after Oral Sessions	5 min.	3 min.	N/A	With additional charge 3 min. (JPY 100,000)
Badge Lanyard	✓	N/A	N/A	N/A
Meeting Room Booking (available during the symposium)	1 per sponsor (small room)	With additional charge (JPY200,000, 300,000)	With additional charge (JPY200,000, 300,000)	With additional charge (JPY200,000, 300,000)
Complimentary Symposium and Banquet Participation	3	2	1	1
Short Presentation Opportunity at Industrial Session	N/A*2	N/A*2	N/A*2	3 min.
Exhibition Booth	N/A*2	N/A*2	N/A*2	✓

Note

*1 TAX included.

*2 Sponsor packages (Diamond, Gold and Silver) do **NOT** include the opportunity to present at the Industrial Session or an exhibit booth. Be sure to also register as an exhibitor if you need them.



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Additional Sponsorship Opportunities

Options	Number of Availability	Unit Price	Note
Ball-point pens (single colored)	1 exclusive	¥200,000	With symposium and company logo
Notepads	1 exclusive	¥200,000	With symposium and company logo
Bags	2	¥500,000	With symposium and company logo
Reusable Water Bottles	1 exclusive	¥300,000	With symposium and company logo
Company Distribution Materials (provided by the sponsor)	No limit	¥100,000	Leaflet or items to be prepared by company. Details to be informed in due course.
Meeting Room for 4 days	7	¥200,000/ ¥300,000	Price depends on the room size.
Promotional Video during Breaks or before/after Oral Sessions (up to 3 min.)	5	¥100,000	Video to be prepared by the company

Note

Each option offers benefits with printed logo of the sponsor along with symposium logo.



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ALL EXHIBITION SPACE ARE ALLOCATED ON A FIRST-COME, FIRST-SERVED BASIS

Exhibition Outline

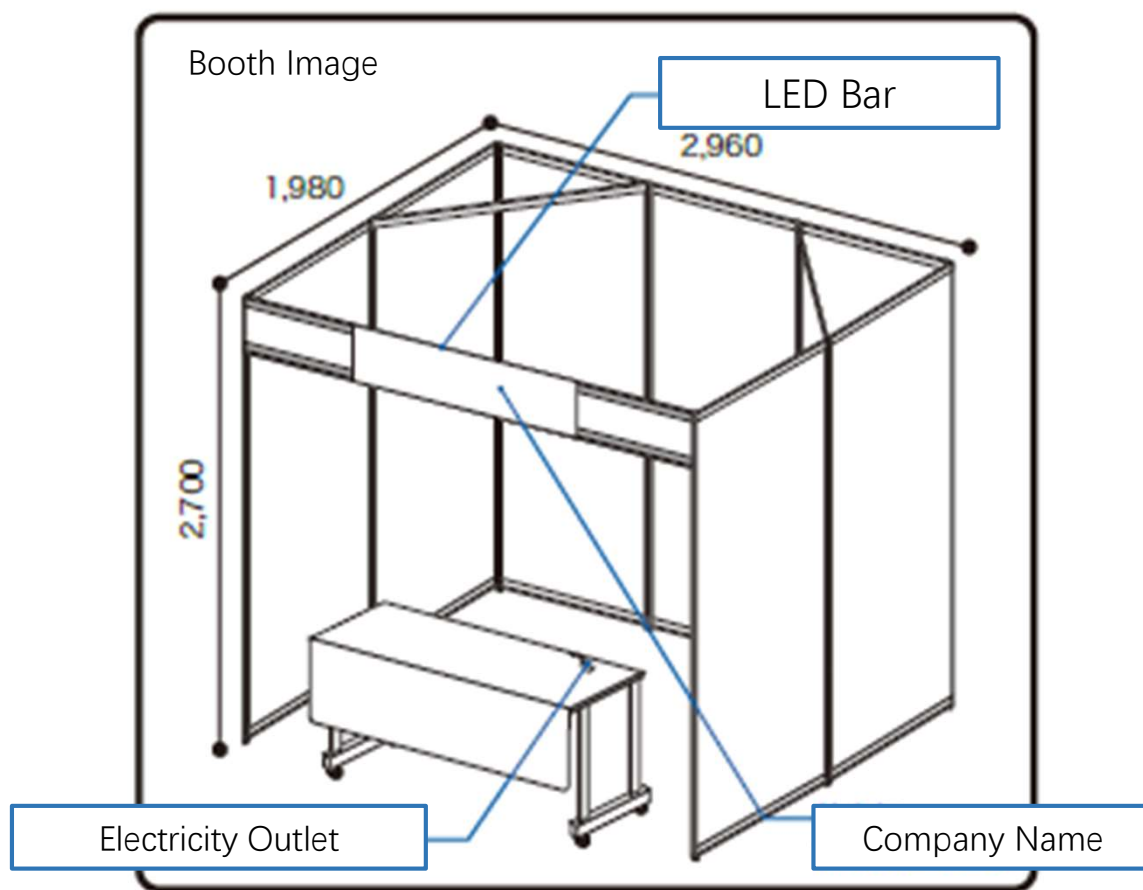
- Venue: Kumamoto-Jo Hall (Kumamoto-city, Japan)
- Dates: Bump-in/Setting up: June 1 (Sun.) 15:00~ (to be confirmed)
- Opening hours: June 2 (Mon.) 8:30~17:30
June 3 (Tue.) 8:30~17:30
June 4 (Wed.) 8:30~17:30
June 5 (Thu.) 8:30~13:30
- Dismantle/Bump-out: June 5 (Thu.) 14:00~
- * Schedule is subject to change. Finalized schedule to be shared in due course.
- Exhibition Area: Large conference room and foyer on the 3rd floor (same area with Poster presentation).
- Exhibition Fee: JPY400,000 per booth.
Up to 2 booths can be booked per company.
Booth can be chosen at the first-come, first-served basis.
- Number of Exhibition booth: Maximum of 32.
Once all booths are fully booked, the application will be closed.
- Benefits: **PR opportunities:**
Company logo on the official website, screen in the symposium hall, symposium program book, and signboards/banners.
Short presentation at the Industrial Session for 3min. which will be held after the Short Course on June 1 (Sun.).
(Light refreshments will be provided to the participants)
- Participation benefits:**
1 Complimentary ticket for admission to the Symposium, Welcome Reception, and Banquet.
3 exhibitor badges to attend the booth
(no access to sessions, lunches) Lunch tickets can be purchased at the registration desk (¥2,000/ticket)



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Booth Specifications

- ✓ 3.0m×2.0m per booth
- ✓ Wall panels on both sides (approx. 2.7 m high)
- ✓ 1 company name sign (W:0.9m x H:2m, white base, black letters)
- ✓ Company name plate design to be standardized for all booths
- ✓ One LED light per booth
- ✓ Two electrical outlets (AC 100V/60Hz, A-type),
- ✓ 1 table (W:1.8m×D:0.45m×H:0.7m) with 2 chairs



Optional Items (i.e. catalogue stands, extra chairs, monitor, etc.) will be arranged upon request.

Catalogue will be shared with exhibitors in January 2025.



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Exhibition Layout (3rd Floor)

Venue:

Kumamoto-Jo Hall

3-40, Sakuramachi, Chuo-ku, Kumamoto-city, Kumamoto, 860-0805

TEL: +81-96-312-3737, FAX: +81-96-312-3738

E-mail: info@kumamoto-jo-hall.jp

Exhibition Area:

Conference room at the 3rd floor, and foyers of the 3rd floor of Kumamoto-Jo Hall

- ✓ Coffee service at the breaking time will be provided to the both areas.
- ✓ Connecting booth is available, but first-come, first-served basis.
- ✓ Note that the oral sessions are held at the 4th floor (main hall).



Booth location can be chosen from the application form. Booth is booked at the first-come, first-served basis. Enlarged floor layout with booth numbers are available on the appendix page.



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Important Notices for Exhibitors

Exhibitors are asked to follow the regulations set by the organizer and venue.

[Prohibited Actions]

There are height restrictions on decorations and exhibits. Please consult with the Sponsor Office in advance. Direct construction on the floor (duct tape, anchors, etc.) is prohibited as a general rule. Power supply, electricity, cleaning, and garbage disposal fees will be charged separately.

[Electricity and water supply and drainage]

Electricity (single-phase, two-wire, 100 V 60 Hz) will be supplied at the exhibitor's request for a fee. If you wish to use this service, please contact the Sponsors' Secretariat. In principle, the use of water, propane gas, and compressed air is prohibited.

[Booth allocation]

Booths can be booked at exhibitors' choice, and it is taken at the first-come, first-served basis. Exhibitors are prohibited from transferring or exchanging all or part of their booths without the organizer's approval.

[Foreign Exhibits]

The exhibition hall will not be a bonded exhibition hall. Exhibits from overseas should be exhibited as domestic cargo or use the ATA Carnet system. For details, please contact the Sponsors' Secretariat.

[Venue management]

ISPSD2025 organizer or Venue are not responsible for accidents, theft, loss or injury to persons in the booths due to natural disasters or other force majeure.

[Others]

Three exhibitor passes for admission to the exhibition hall will be provided per booth per application.

The passes you will receive will not allow you to participate in the lecture hall and related programs of the ISPSD2025. If you wish to attend the conference program, please purchase a separate participation pass.

The Exhibitor Manual will be shared with the exhibitors in due course along with the order form for the optional items/services.



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How to Apply and Future Procedure

1) How to Apply

Please apply from our official website (<https://www.ispsd2025.com/>) on the page of "Sponsorship & Exhibition".

2) Payment Method

After confirming your application, the Sponsor Secretariat Office will issue an invoice. Please transfer the invoiced amount to the designated bank account within one month of the invoice date.

All payments should be made in Japanese Yen, and bank transfer charges are to be borne by the remitter company.

3) Cancellation Policy

- ◆ No cancellations will be accepted after the application form has been submitted. However, if cancellation is caused by unavoidable reasons, please write to the organizer for the circumstances, and the organizer has the right to accept/decline the cancellation/withdrawal requests.
If cancellation is approved, you may be charged for expenses incurred at that time.
- ◆ The exhibition period and venue may be changed due to unavoidable circumstances. In principle, applications cannot be cancelled due to such changes. In the event of a postponement, applications that have already been submitted will, in principle, be moved to the postponed date. No compensation will be provided for damages caused by these changes.
- ◆ Infection control measures: At this time, we hope and assume that the event will be held on site, but depending on the infection situation, we may have to give priority to infection control measures.

4) Contact/Enquiries

Please contact the ISPSD2025 Sponsorship Office for any enquiries.

ISPSD 2025 Sponsorship Office

c/o Convention Linkage, Inc.

2-17 Sakuramachi, Chuo-ku, Kumamoto City 860-0805, JAPAN

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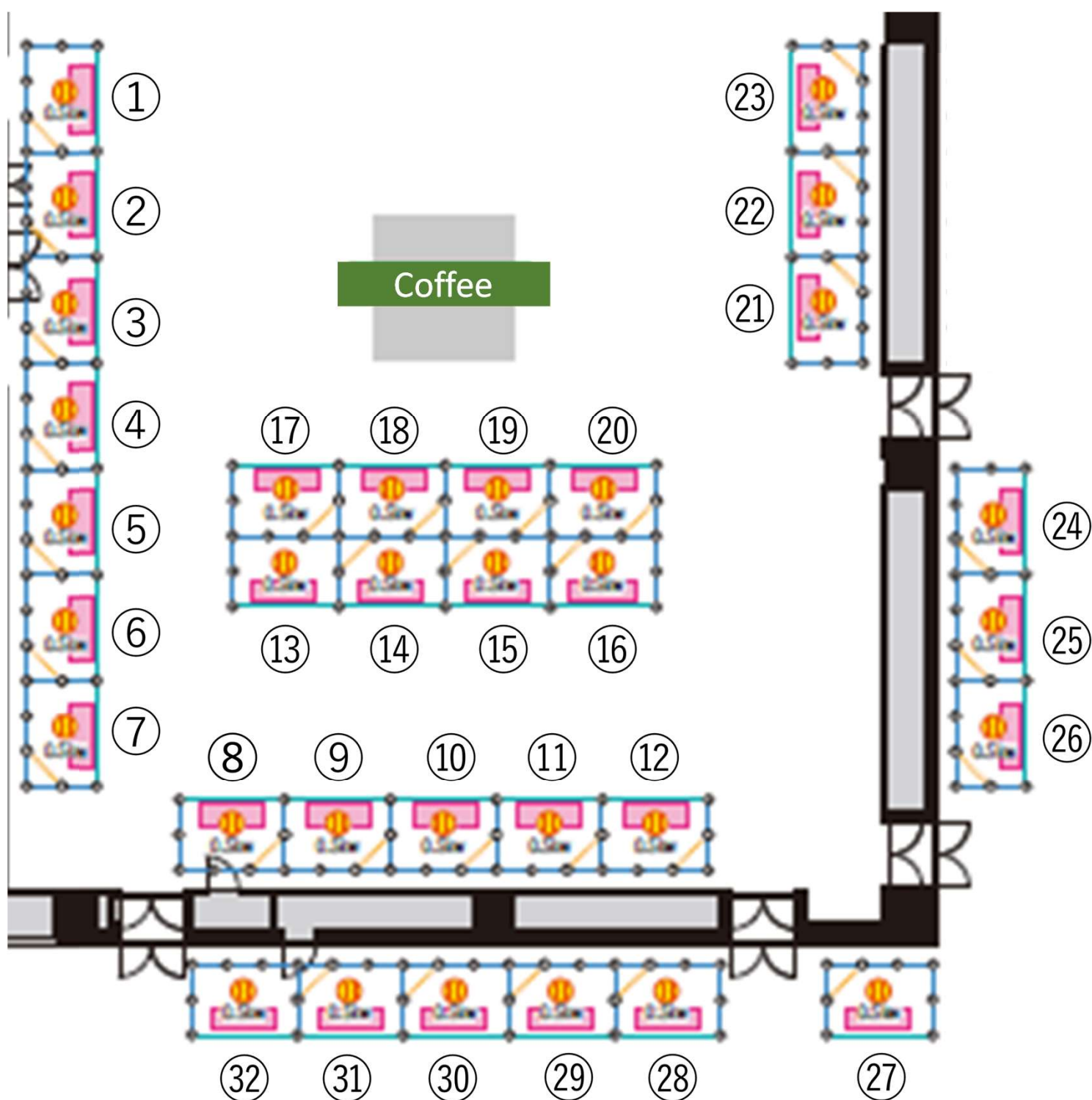
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APPENDIX (booth numbers)



Coffee



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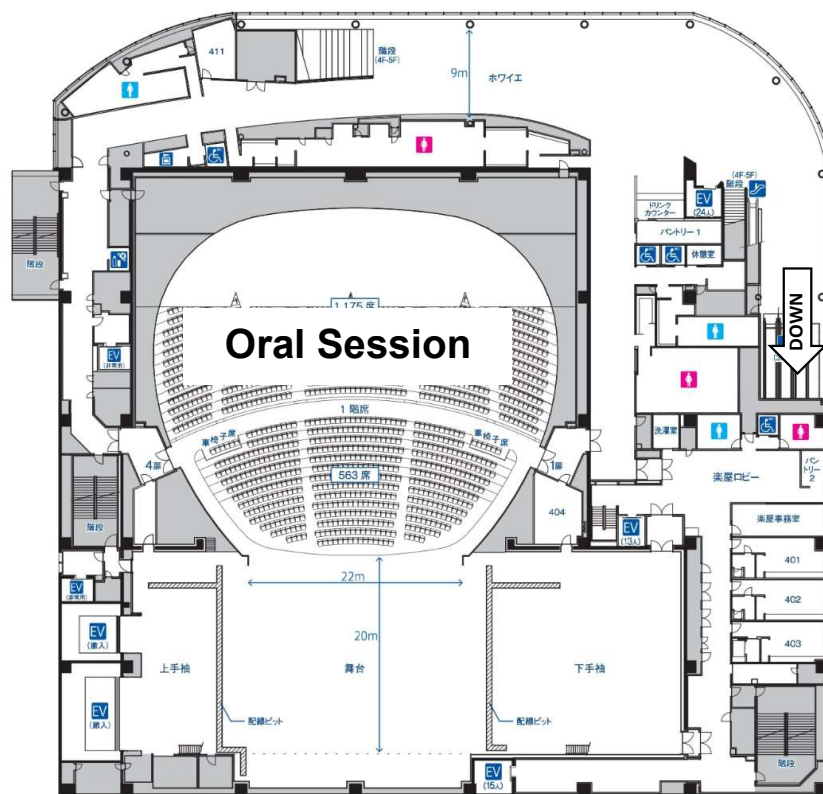
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APPENDIX (Floors)

4th Floor



3rd Floor

